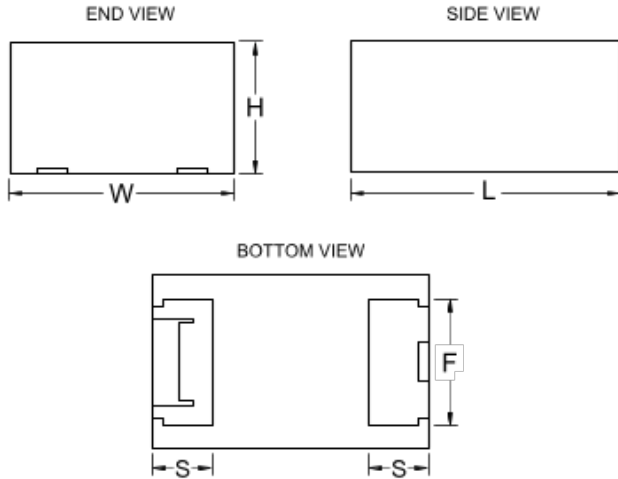


T548H337M016APE070

Not for New Design

T548, Tantalum, Polymer Tantalum, Reduced Volume, 330 uF, 20%, 16 VDC, SMD, Polymer, Molded, Face Down Terminals, 70 mOhms, 7360, Height Max = 2mm



Click [here](#) for the 3D model.

Dimensions	
Footprint	7360
L	7.3mm +/-0.3mm
W	6mm +/-0.3mm
H	1.9mm +/-0.1mm
S	1.6mm +/-0.3mm
F	4.45mm +/-0.1mm

Packaging Specifications	
Packaging	T&R, 178mm
Packaging Quantity	1000

General Information	
Series	T548
Dielectric	Polymer Tantalum
Style	SMD Chip
Description	SMD, Polymer, Molded, Face Down Terminals
Features	Face Down
RoHS	Yes
Termination	Nickel Palladium Gold
AEC-Q200	No
Component Weight	384.64 mg
Miscellaneous	Not recommended for new designs. Please use the T523 series instead.
MSL	4

Specifications	
Capacitance	330 uF
Capacitance Tolerance	20%
Voltage DC	16 VDC (85C)
Temperature Range	-55/+85°C
Rated Temperature	85°C
Humidity	60C, 90% RH, 500 Hours, No Load
Dissipation Factor	10% 120Hz 25C
Failure Rate	N/A
Resistance	70 mOhms (100kHz 25C)
Ripple Current	2510 mA (rms, 100kHz 45C), 1757 mA (rms, 85C)
Leakage Current	528 uA (5min 25°C)

Statements of suitability for certain applications are based on our knowledge of typical operating conditions for such applications, but are not intended to constitute - and we specifically disclaim - any warranty concerning suitability for a specific customer application or use. This information is intended for use only by customers who have the requisite experience and capability to determine the correct products for their application. Any technical advice inferred from this information or otherwise provided by us with reference to the use of our products is given gratis, and we assume no obligation or liability for the advice given or results obtained.